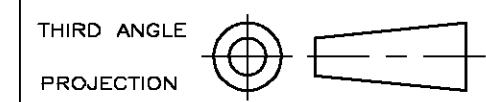


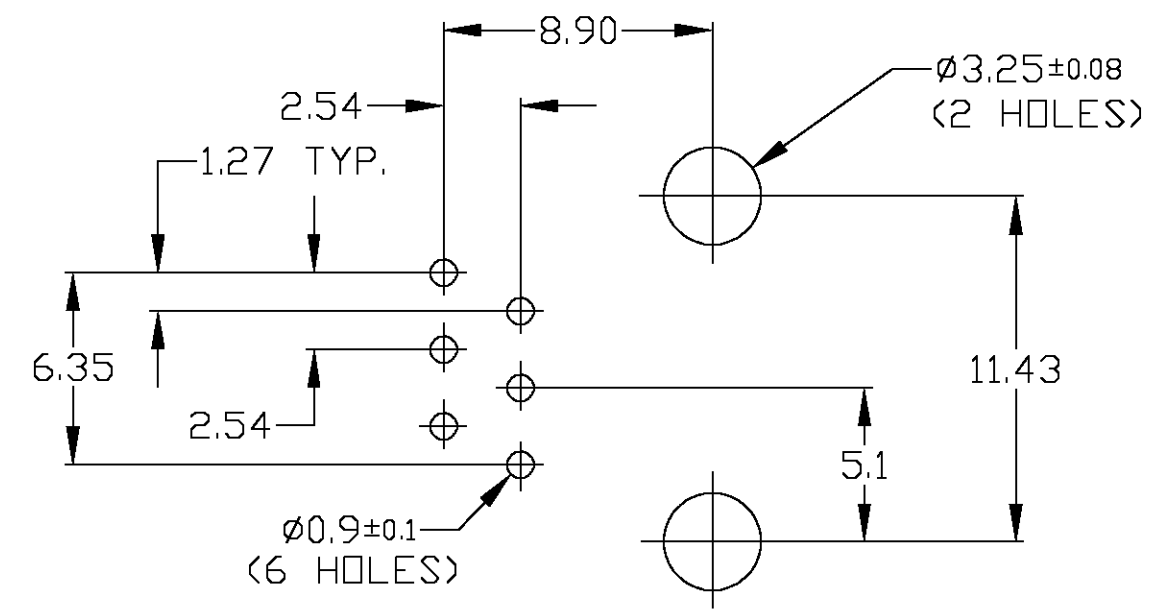
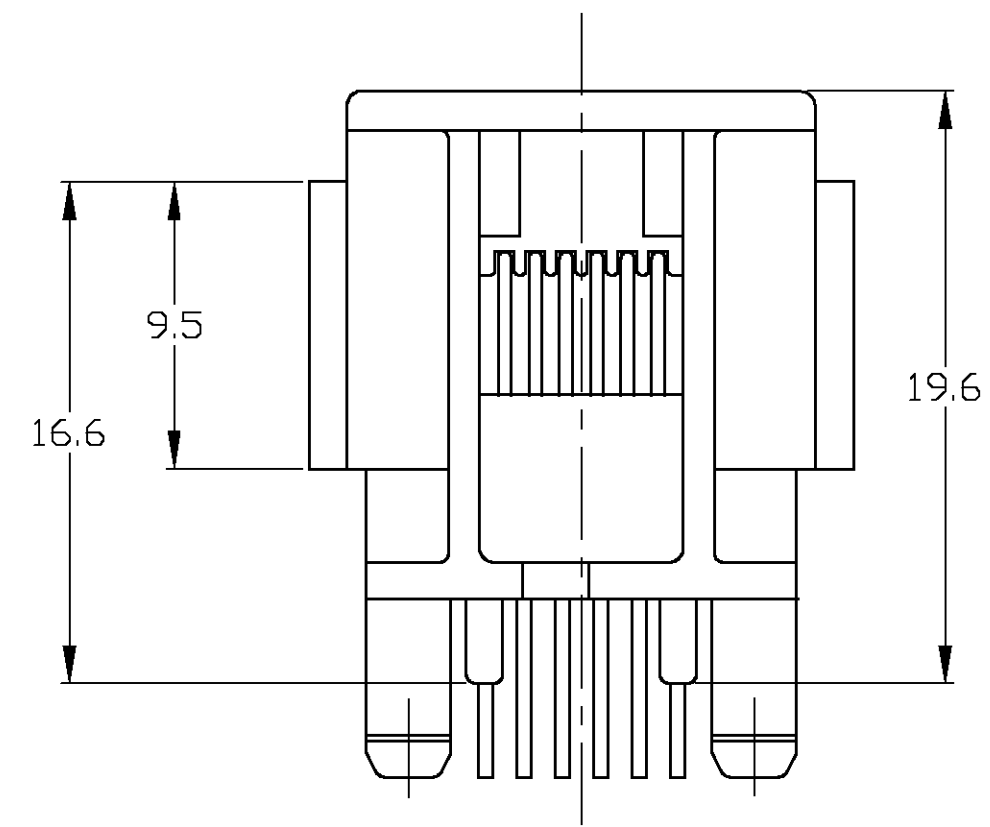
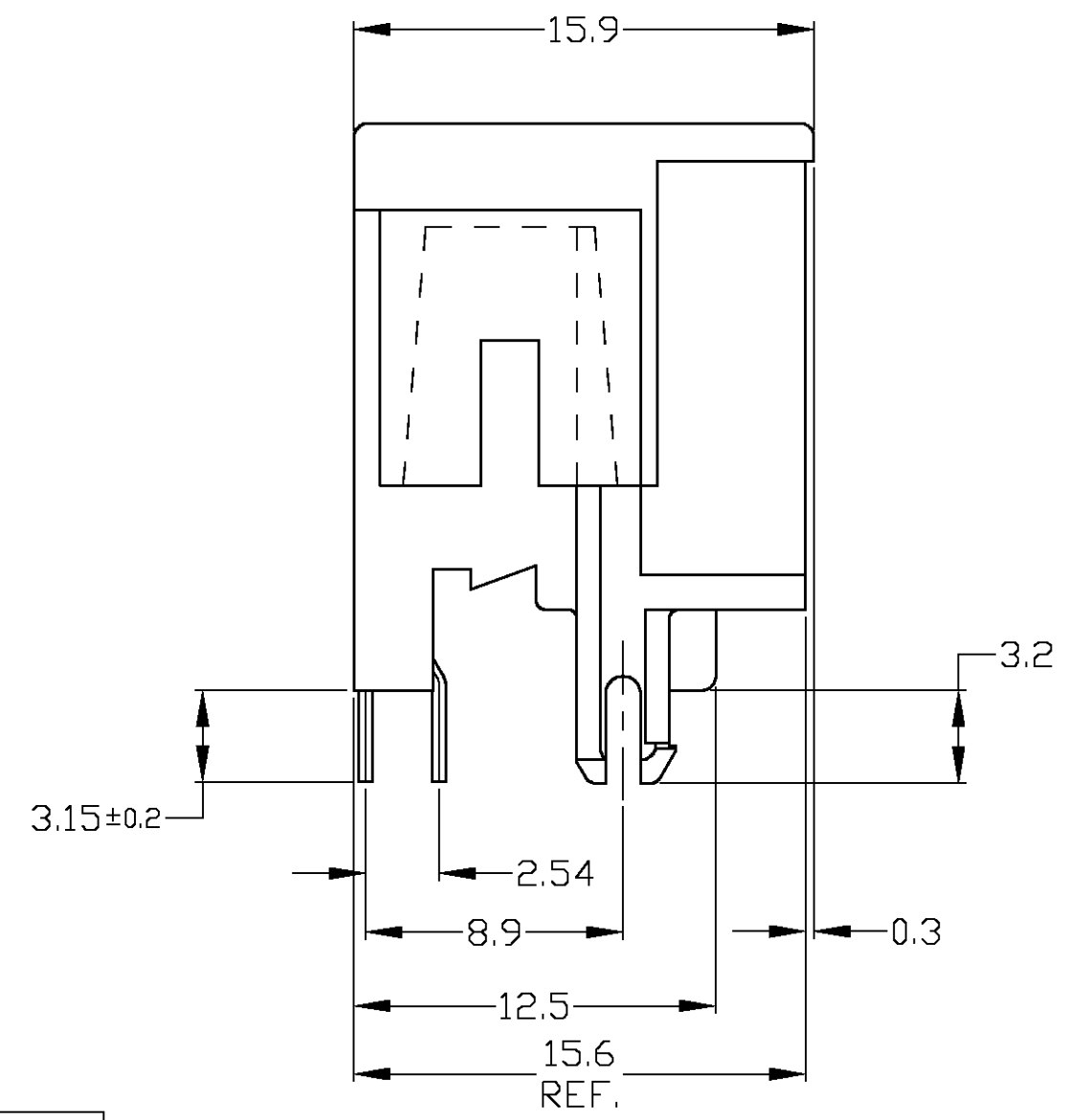
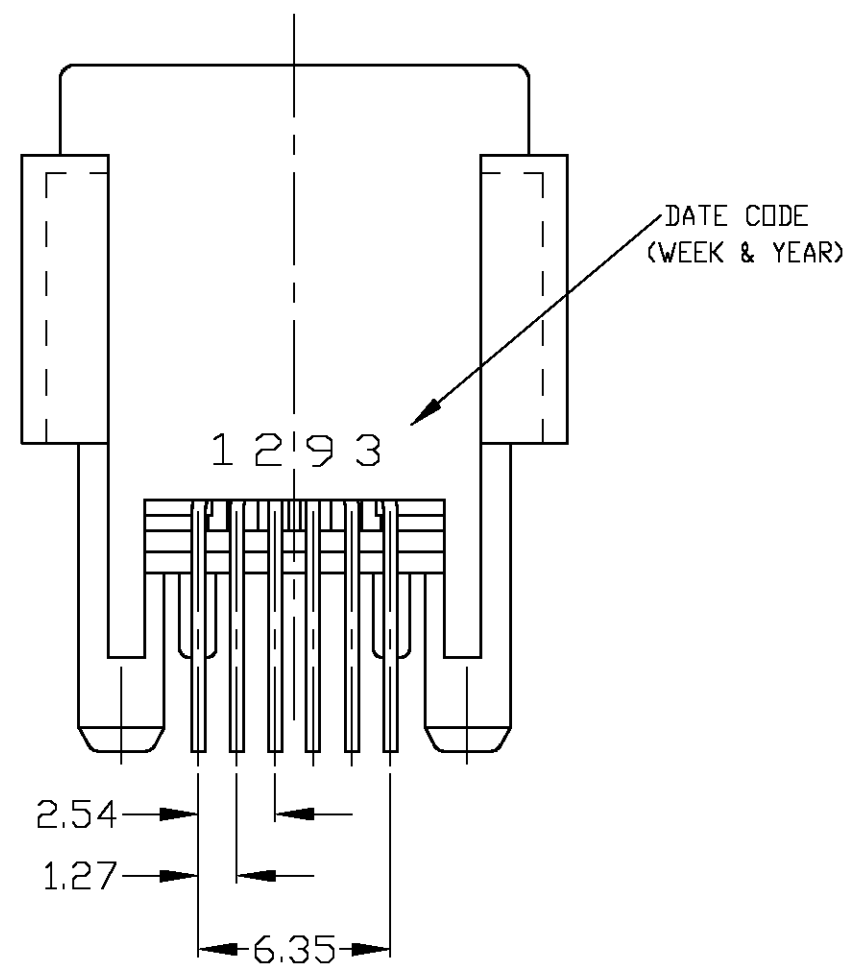
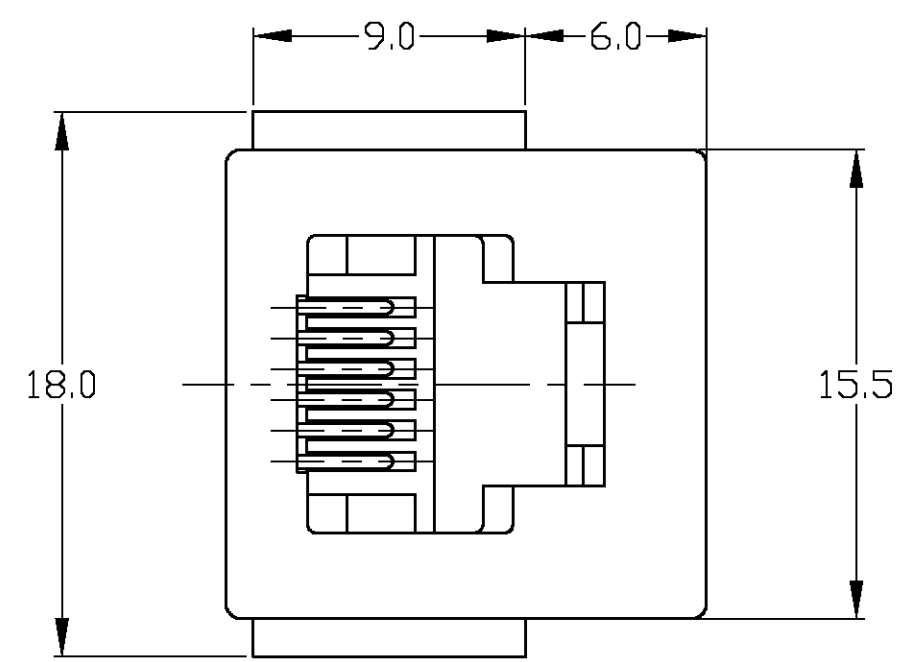
DO NOT SCALE
DIMENSIONS IN mm

METRIC



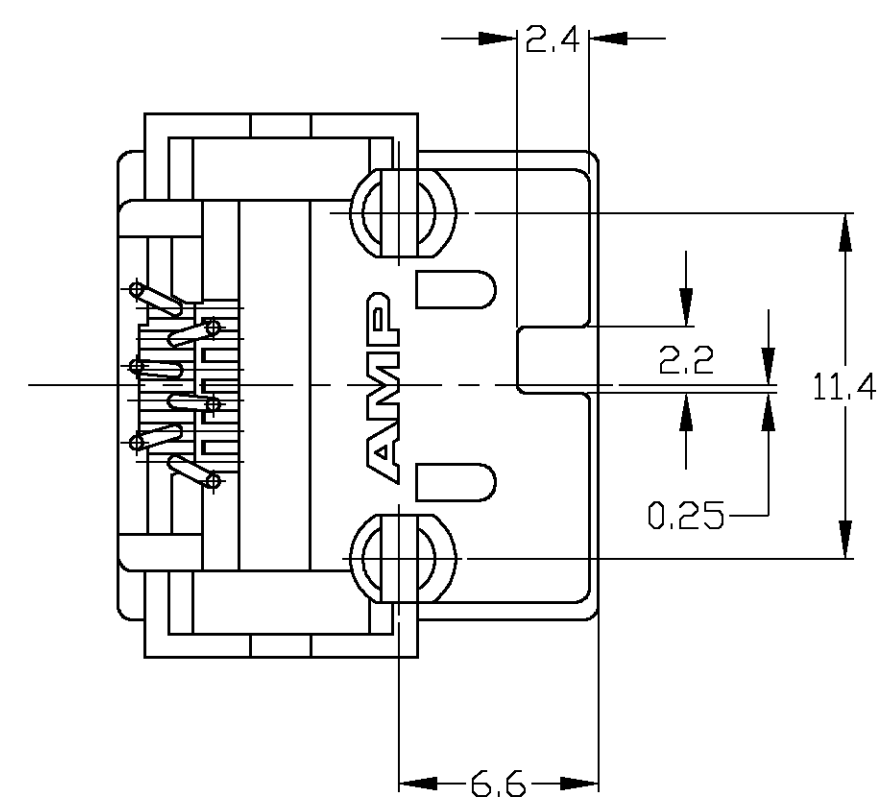
NOTES:

- 1 TOLERANCES UNLESS OTHERWISE SPECIFIED: $\pm 0,15$
- 2 FOR APPLICATION INFORMATION SEE AMP SPEC. 114-19019
- 3 FOR PERFORMANCE REQUIREMENTS SEE AMP SPEC. 108-19064
- 4 PACKAGING: BULK PACKAGED.
TRUE POSITIONING OF THE SOLDER TINES
MAY BE AFFECTED BY BULK PACKAGING.



PRINTED CIRCUIT BOARD LAYOUT

[VIEW SHOWN IS CIRCUIT (NONCOMPONENT) SIDE OF BOARD.]
PRINTED CIRCUIT BOARD THICKNESS: 1,6 mm NOMINAL.
TOLERANCES UNLESS OTHERWISE SPECIFIED $\pm 0,05$.



6 POSITIONS / 6 CONTACTS		<u>IN CONTACT AREA</u> 1,2µm MIN SEL HARD GOLD OVER 1,2µm MIN NICKEL			<u>HOUSING</u> PBT, UL 94V-0 COLOR: BLACK		100190-2	
		<u>SOLDER TINES</u> 2,0µm MIN TIN-LEAD OVER 1,2µm MIN NICKEL			<u>CONTACTS</u> PHOSPHOR BRONZE			
REMARKS		FINISH			MATERIAL		P/N	
					CUSTOMER DRAWING			FOR REFERENCE ONLY WILL NOT BE UPDATED
F	SR10-0084-02	KV		06 FEB 02	© COPYRIGHT 19 BY AMP HOLLAND B.V.			
E	EH-1142-97	EvE	W.B.	19 NOV 97	ALL INTERNATIONAL RIGHTS RESERVED.AMP PRODUCTS MAY BE COVERED BY U.S. AND FOREIGN AND/OR PATENTS PENDING.			
D	EH-0217-93	R.D.		04-11-93	THIS DRAWING IS UNPUBLISHED RELEASED FOR PUBLICATION			
C	H-9194	D.K.		09-03-92				Tyco Electronics Corporation Oostkamp - BELGIUM
B	H-9194	JvdH		16-10-91	NAME MODULAR JACK, 6 POS., TOP ENTRY			
A	H-9194	JvdH		09-10-91	HIGH PROFILE, WITH PANEL STOPS			
LTR.	REVISION RECORD	DR.	CHK.	DATE	FOR PRINTED CIRCUIT BOARD			
DR.: J.V.D.HEIJDEN DATE: 09-10-91		CHK.: C.STERKEN DATE:		APP.: L.V.SOEST DATE:		DWG.No. C- 100190		REV.LTR. F
								SHEET 1 OF 1
								A2